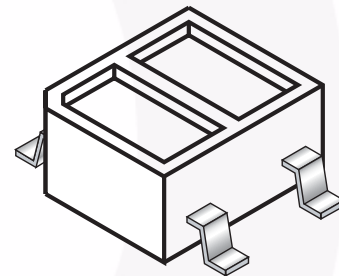
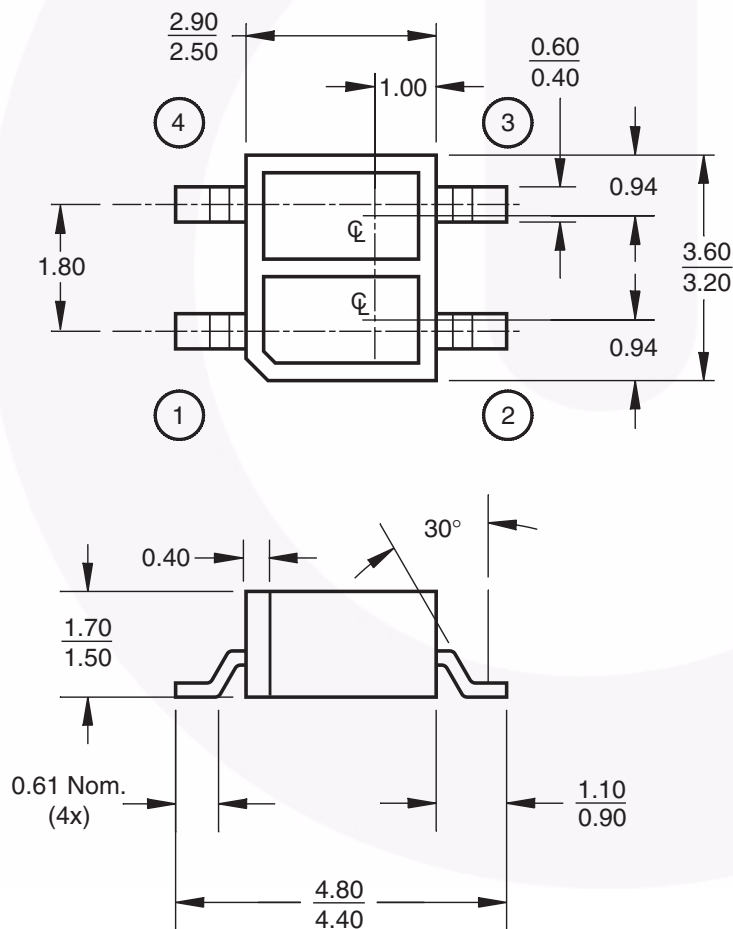


QRE1113, QRE1113GR Miniature Reflective Object Sensor

Features

- Phototransistor output
- No contact surface sensing
- Miniature package
- Lead form style: Gull Wing
- Two leadform options: Through hole (QRE1113)
SMT gullwing (QRE1113GR)
- Two packaging options: Tube (QRE1113)
Tape and reel (QRE1113GR)

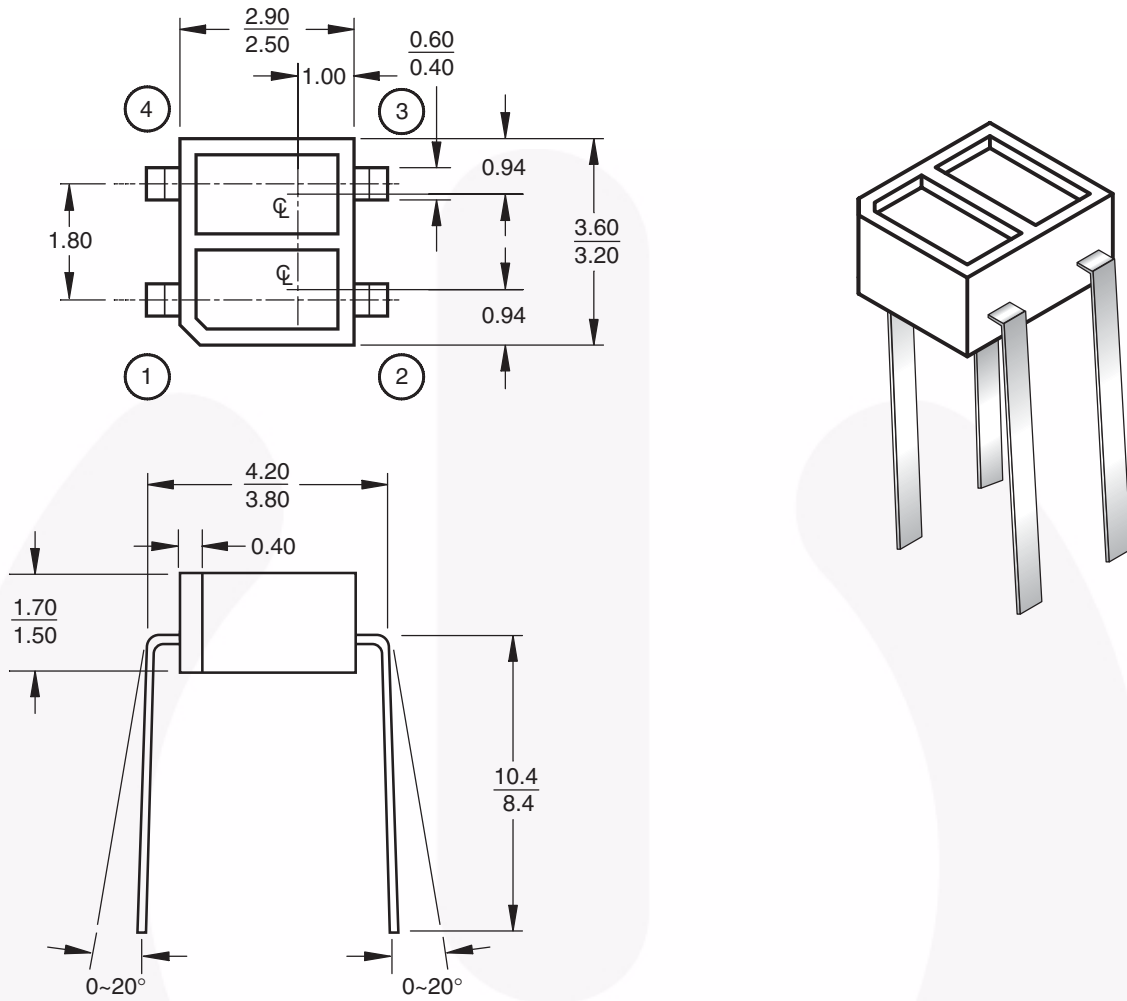
QRE1113GR Package Dimensions



Notes:

1. Dimensions for all drawings are in millimeters.
2. Tolerance of ± 0.15 mm on all non-nominal dimensions

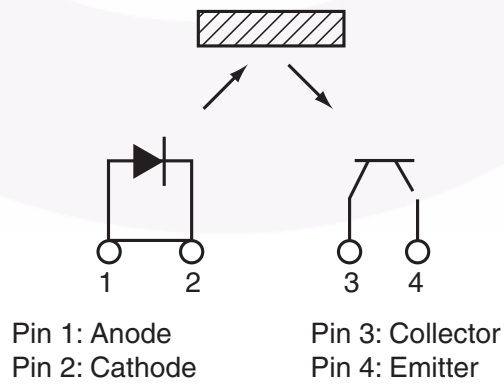
QRE1113 Package Dimensions



Notes:

- 1. Dimensions for all drawings are in millimeters.
- 2. Tolerance of $\pm 0.15\text{mm}$ on all non-nominal dimensions

Schematic



Absolute Maximum Ratings ($T_A = 25^\circ\text{C}$ unless otherwise specified)

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter	Rating	Units
T_{OPR}	Operating Temperature	-40 to +85	$^\circ\text{C}$
T_{STG}	Storage Temperature	-40 to +90	$^\circ\text{C}$
T_{SOL-I}	Soldering Temperature (Iron) ^(2,3,4)	240 for 5 sec	$^\circ\text{C}$
T_{SOL-F}	Soldering Temperature (Flow) ^(2,3)	260 for 10 sec	$^\circ\text{C}$
EMITTER			
I_F	Continuous Forward Current	50	mA
V_R	Reverse Voltage	5	V
I_{FP}	Peak Forward Current ⁽⁵⁾	1	A
P_D	Power Dissipation ⁽¹⁾	75	mW
SENSOR			
V_{CEO}	Collector-Emitter Voltage	30	V
V_{ECO}	Emitter-Collector Voltage	5	V
I_C	Collector Current	20	mA
P_D	Power Dissipation ⁽¹⁾	50	mW

Electrical/Optical Characteristics ($T_A = 25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
INPUT DIODE						
V_F	Forward Voltage	$I_F = 20\text{mA}$		1.2	1.6	V
I_R	Reverse Leakage Current	$V_R = 5\text{V}$			10	μA
λ_{PE}	Peak Emission Wavelength	$I_F = 20\text{mA}$		940		nm
OUTPUT TRANSISTOR						
I_D	Collector-Emitter Dark Current	$I_F = 0\text{mA}, V_{CE} = 20\text{V}$			100	nA
COUPLED						
$I_{C(ON)}$	On-State Collector Current	$I_F = 20\text{mA}, V_{CE} = 5\text{V}^{(6)}$	0.10	0.40		mA
I_{CX}	Cross-Talk Collector Current	$I_F = 20\text{mA}, V_{CE} = 5\text{V}^{(7)}$			1	μA
$V_{CE(SAT)}$	Saturation Voltage				0.3	V
t_r	Rise Time	$V_{CC} = 5\text{V}, I_{C(ON)} = 100\mu\text{A}, R_L = 1\text{k}\Omega$		20		μs
t_f	Fall Time			20		

Notes:

- Derate power dissipation linearly 1.00mW/ $^\circ\text{C}$ above 25 $^\circ\text{C}$.
- RMA flux is recommended.
- Methanol or isopropyl alcohols are recommended as cleaning agents.
- Soldering iron 1/16" (1.6mm) from housing.
- Pulse conditions: $t_p = 100\mu\text{s}$; $T = 10\text{ms}$.
- Measured using an aluminum alloy mirror at $d = 1\text{mm}$.
- No reflective surface at close proximity.

Typical Performance Curves

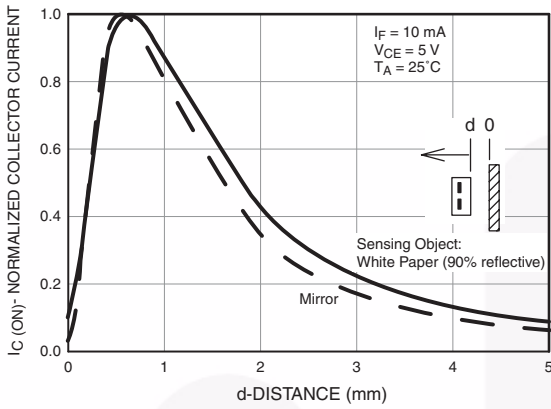


Fig. 1 Normalized Collector Current vs. Distance between device and reflector

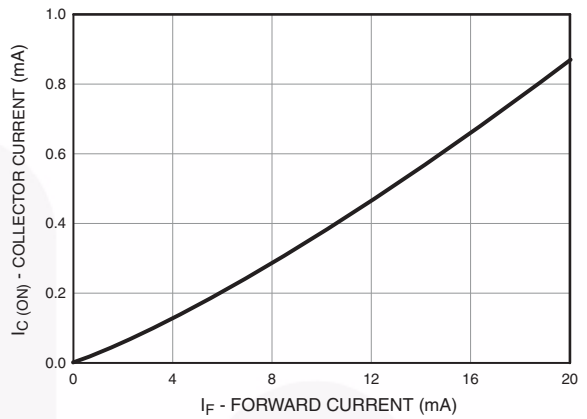


Fig. 2 Collector Current vs. Forward Current

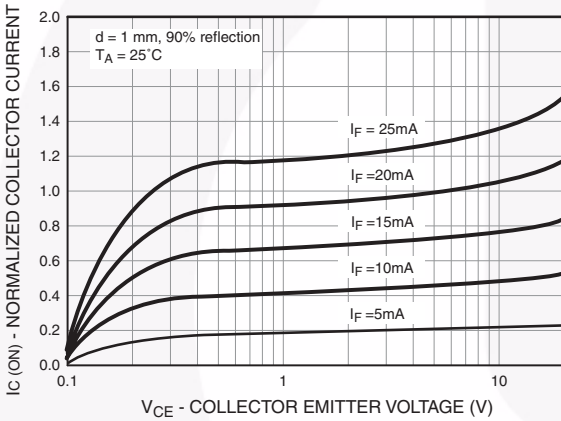


Fig. 3 Normalized Collector Current vs. Collector to Emitter Voltage

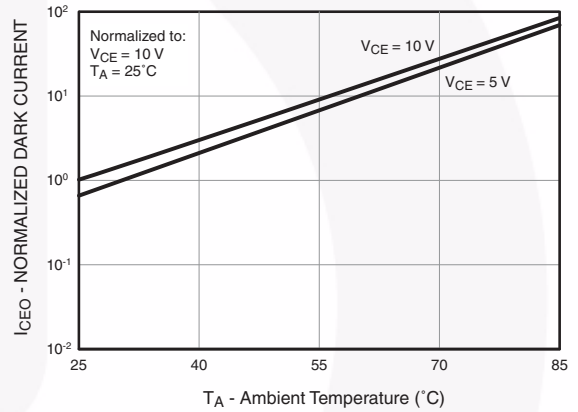


Fig. 4 Collector Emitter Dark Current (Normalized) vs. Ambient Temperature

Typical Performance Curves (Continued)

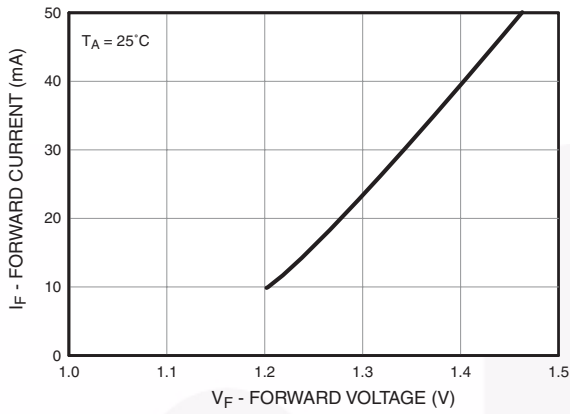


Fig. 6 Forward Current vs. Forward Voltage

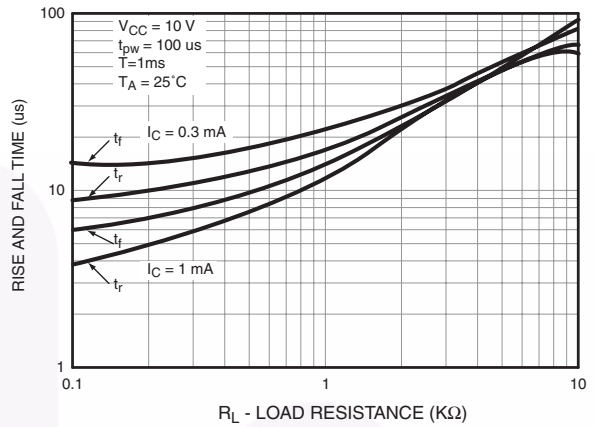


Fig. 7 Rise and Fall Time vs. Load Resistance

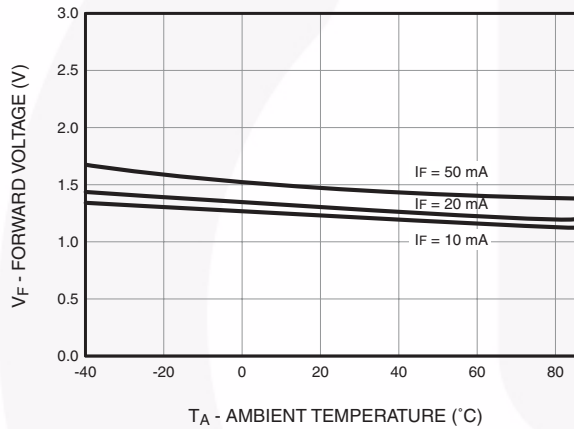


Fig. 8 Forward Voltage vs. Ambient Temperature

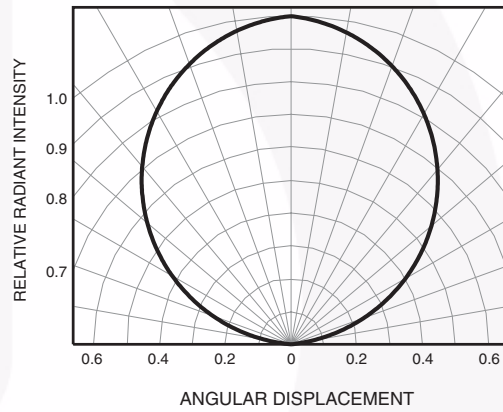
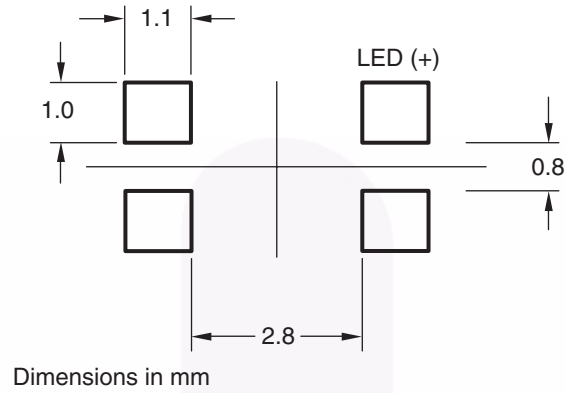
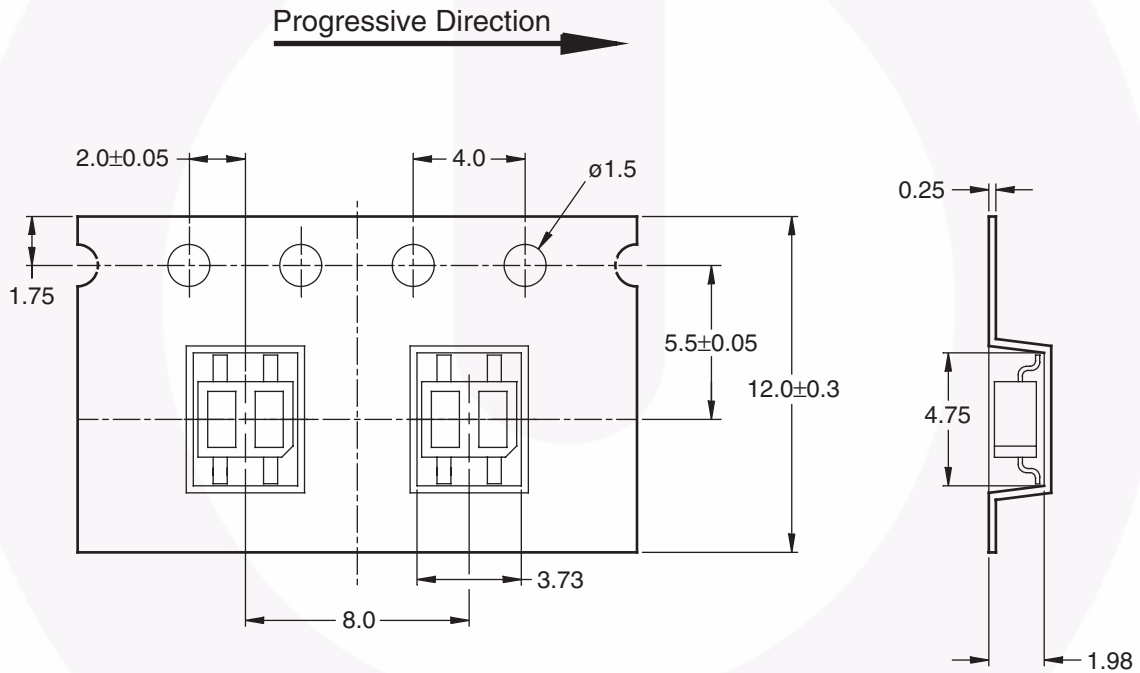


Fig. 8 Radiation Diagram

Recommended Solder Screen Pattern for GR option (for reference only)



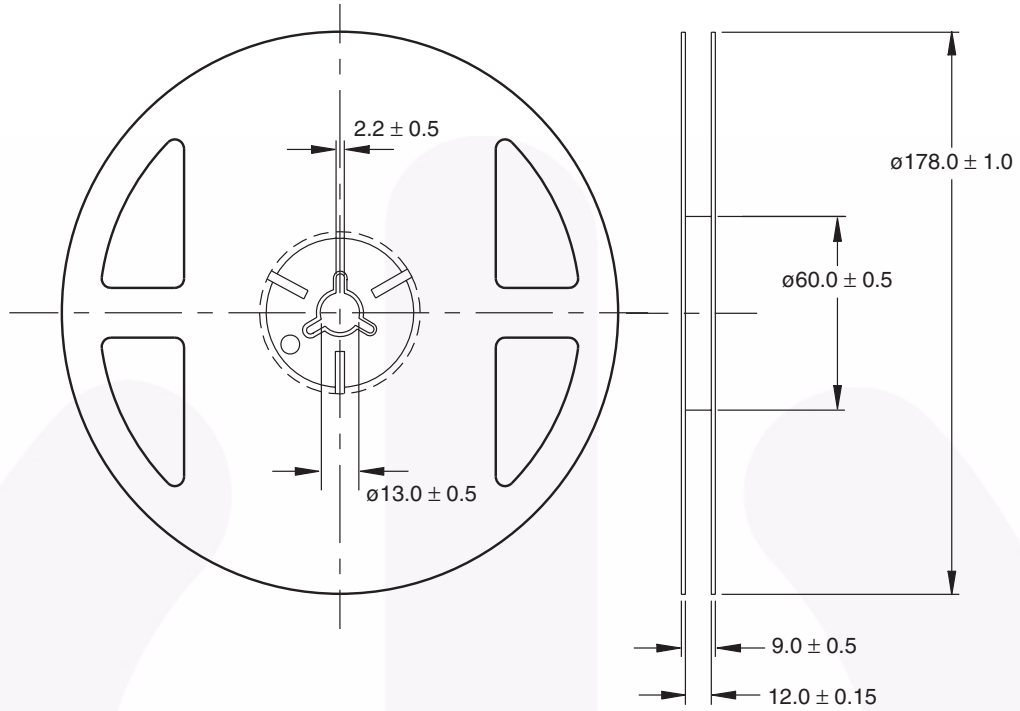
Taping Dimensions for GR option



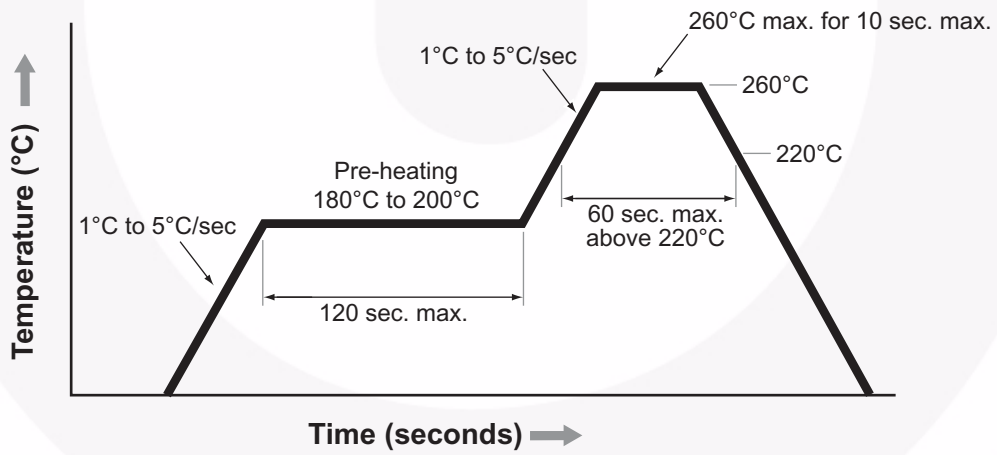
General tolerance ± 0.1
 Dimensions in mm



Reel Dimensions



Reflow Profile








Note: Reflow soldering should not be done more than twice.



TRADEMARKS

The following includes registered and unregistered trademarks and service marks, owned by Fairchild Semiconductor and/or its global subsidiaries, and is not intended to be an exhaustive list of all such trademarks.

- | | | | |
|---|---|---|---|
| AccuPower™ | FPS™ | Power-SPM™ | The Power Franchise® |
| Auto-SPM™ | F-PFS™ | PowerTrench® | The Right Technology for Your Success™ |
| AX-CAP™ | FRFET® | PowerXS™ | the power franchises |
| BitSiC® | Global Power Resource™ | Programmable Active Droop™ | TinyBoost™ |
| Build it Now™ | Green FPST™ | QFET® | TinyBuck™ |
| CorePLUSt™ | Green FPST™ e-Series™ | QS™ | TinyCalc™ |
| CorePOWER™ | Gmax™ | Quiet Series™ | TinyLogic® |
| CROSSVOL™ | GTO™ | RapidConfigure™ | TINYOPTO™ |
| CTL™ | IntelliMAX™ |  | TinyPower™ |
| Current Transfer Logic™ | ISOPLANAR™ | Saving our world, 1mW/W at a time™ | TinyPVM™ |
| DEUXPEED® | MegaBuck™ | SignalWise™ | TinyWire™ |
| Dual Cool™ | MICROCOUPLER™ | SmartMax™ | TranSiC® |
| EcoSPARK® | MicroFET™ | SMART START™ | TriFault Detect™ |
| EfficientMax™ | MicroPak™ | SPM® | TRUECURRENT® |
| ESBC™ | MicroPak2™ | STEALTH™ | µSerDes™ |
|  | MillerDrive™ | SuperFET® |  |
| Fairchild® | MotionMax™ | SuperSOT™-3 | UHC® |
| Fairchild Semiconductor® | Motion-SPM™ | SuperSOT™-8 | Ultra FRFET™ |
| FACT Quiet Series™ | mWSaver™ | SuperSOT™-8 | UniFET™ |
| FACT® | OptoHiT™ | SupreMOS® | VCX™ |
| FAST® | OPTOLOGIC® | SyncFET™ | VisualMax™ |
| FastvCore™ | OPTOPLANAR® | Sync-Lock™ | XST™ |
| FETBench™ |  |  | |
| FlashWriter® | PDP SPM™ | | |

* Trademarks of System General Corporation, used under license by Fairchild Semiconductor.

DISCLAIMER

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION, OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS. THESE SPECIFICATIONS DO NOT EXPAND THE TERMS OF FAIRCHILD'S WORLDWIDE TERMS AND CONDITIONS, SPECIFICALLY THE WARRANTY THEREIN, WHICH COVERS THESE PRODUCTS.

LIFE SUPPORT POLICY

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION.

As used herein:

- Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user.
- A critical component in any component of a life support, device, or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

ANTI-COUNTERFEITING POLICY

Fairchild Semiconductor Corporation's Anti-Counterfeiting Policy. Fairchild's Anti-Counterfeiting Policy is also stated on our external website, www.fairchildsemi.com, under Sales Support.

Counterfeiting of semiconductor parts is a growing problem in the industry. All manufacturers of semiconductor products are experiencing counterfeiting of their parts. Customers who inadvertently purchase counterfeit parts experience many problems such as loss of brand reputation, substandard performance, failed applications, and increased cost of production and manufacturing delays. Fairchild is taking strong measures to protect ourselves and our customers from the proliferation of counterfeit parts. Fairchild strongly encourages customers to purchase Fairchild parts either directly from Fairchild or from Authorized Fairchild Distributors who are listed by country on our web page cited above. Products customers buy either from Fairchild directly or from Authorized Fairchild Distributors are genuine parts, have full traceability, meet Fairchild's quality standards for handling and storage and provide access to Fairchild's full range of up-to-date technical and product information. Fairchild and our Authorized Distributors will stand behind all warranties and will appropriately address any warranty issues that may arise. Fairchild will not provide any warranty coverage or other assistance for parts bought from Unauthorized Sources. Fairchild is committed to combat this global problem and encourage our customers to do their part in stopping this practice by buying direct or from authorized distributors.

PRODUCT STATUS DEFINITIONS

Definition of Terms

Datasheet Identification	Product Status	Definition
Advance Information	Formative / In Design	Datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	Datasheet contains preliminary data, supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.
No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.
Obsolete	Not In Production	Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.

Rev. I54



Компания «ЭлектроПласт» предлагает заключение долгосрочных отношений при поставках импортных электронных компонентов на взаимовыгодных условиях!

Наши преимущества:

- Оперативные поставки широкого спектра электронных компонентов отечественного и импортного производства напрямую от производителей и с крупнейших мировых складов;
- Поставка более 17-ти миллионов наименований электронных компонентов;
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- Лицензия ФСБ на осуществление работ с использованием сведений, составляющих государственную тайну;
- Поставка специализированных компонентов (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Aeroflex, Peregrine, Syfer, Eurofarad, Texas Instrument, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Помимо этого, одним из направлений компании «ЭлектроПласт» является направление «Источники питания». Мы предлагаем Вам помощь Конструкторского отдела:

- Подбор оптимального решения, техническое обоснование при выборе компонента;
- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



Как с нами связаться

Телефон: 8 (812) 309 58 32 (многоканальный)

Факс: 8 (812) 320-02-42

Электронная почта: org@eplast1.ru

Адрес: 198099, г. Санкт-Петербург, ул. Калинина, дом 2, корпус 4, литера А.